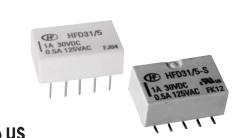
# HFD31

**CONTACT DATA** 

Mechanical endurance

Electrical endurance 2)

# SUBMINIATURE SIGNAL RELAY



### Features

- Offers excellent board space savings
- Surge withstand voltage up to 1500V, meets FCC Part 68
- High contact capacity 1A 30VDC
- Low power consumption

**CHARACTERISTICS** 

- Single side stable and latching type available
- Single or double coil winding type available
- Environmental friendly product (RoHS compliant)
- Outline Dimensions: (14.0 x 9.0 x 5.0) mm

#### 2C Contact arrangement Contact resistance $100m\Omega$ max. (at 10mA 30mVDC) Contact material AgPd + Au plated, AgNi + Au plated Contact rating 1A 30VDC (Res. load) 0.5A 125VAC Max. switching current 2A Max. switching voltage 125VAC/110VDC Max. switching power 62.5VA / 30W Min. applicable load 1) 10mV 10µA

Notes: 1) Min. applicable load is reference value. Please perform the confirmation test with the actual load before production since reference value may change according to switching frequencies, environmental conditions and expected contact resistance and

reliability.
2) Electric endurance data are collected in one pair CO contact test.

1 x 10<sup>8</sup>ops

1 x 10<sup>5</sup>ops (0.5A 125VAC,

at 70°C, 1s on 9s off)

Resistive load, AgNi + Au plated,

Insulation	resistance	1000MΩ (at 500VDC)		
	Between coil & contacts	1000VAC 1min		
Dielectric strength	Between open contacts	750VAC 1min		
Suengui	Between contact sets	1000VAC 1min		
Ü	nstand voltage pen contacts (10/160µs)	1500VAC (FCC part 68)		
Operate t	ime (Set time)	3ms max.		
Release t	ime (Reset time)	3ms max.		
Ambient t	emperature	-40°C to 70°C		
Humidity		5% to 85% RH		
Vibration	resistance	10Hz to 55Hz 3.0mm DA		
Shock	Functional	490m/s <sup>2</sup>		
resistance	Destructive	980m/s <sup>2</sup>		
Termination	on	DIP, SMT		
Unit weig	ht	Approx. 1.5g		
Moisture	sensitivity levels (Only for	MSL-3		
SMT type	, JEDEC-STD-020)	WISE-3		
Construct	ion	Plastic sealed		

Notes: 1) The data shown above are initial values.

2) UL insulation system: Class A

COIL								
Coil power		Approx. 140mW						
	Single side stable	(24VDC: Approx. 200mW)						
	1 coil latching	Approx.100mW						
		(24VDC: Approx.150mW)						
	2 coils latching	Approx. 200mW						
		(24VDC:Approx. 300mW)						

SAFETY APPROVAL RATINGS							
		1A 30VDC					
/61	AgNi + Au plated	2A 30VDC					
UL/CUL		0.5A 125VAC					
	AgPd + Au plated	0.5A 125VAC					

Notes: 1) All values unspecified are at room temperature.

2) Only typical loads are listed above. Other load specifications

COIL DATA at 23°C

## Single side stable

Coil Code	Nominal Voltage VDC	Pick-up Voltage VDC max.	Drop-out Voltage VDC min.	Coil Resistance Ω	Nominal Power mW approx.	Max. Voltage VDC
HFD31/1.5	1.5	1.13	0.15	16 x (1±10%)	140	2.25
HFD31/2.4	2.4	1.8	0.24	41.3 x (1±10%)	140	3.6
HFD31/3	3	2.25	0.3	64.3 x (1±10%)	140	4.5
HFD31/4.5	4.5	3.38	0.45	145 x (1±10%)	140	6.7
HFD31/5	5	3.75	0.5	178 x (1±10%)	140	7.5
HFD31/6	6	4.5	0.6	257 x (1±10%)	140	9
HFD31/9	9	6.75	0.9	579 x (1±10%)	140	13.5
HFD31/12	12	9	1.2	1028 x (1±10%)	140	18
HFD31/24	24	18	2.4	2880 x (1±10%)	200	36

## 1 coil latching

Coil Code	Nominal Voltage VDC	Set Voltage VDC max.	Reset Voltage VDC max.	Coil Resistance Ω	Nominal Power mW approx.	Max. Voltage VDC
HFD31/1.5-L1	1.5	1.13	1.13	22.5 x (1±10%)	100	2.25
HFD31/2.4-L1	2.4	1.8	1.8	58 x (1±10%)	100	3.6
HFD31/3-L1	3	2.25	2.25	90 x (1±10%)	100	4.5
HFD31/4.5-L1	4.5	3.38	3.38	203 x (1±10%)	100	6.7
HFD31/5-L1	5	3.75	3.75	250 x (1±10%)	100	7.5
HFD31/6-L1	6	4.5	4.5	360 x (1±10%)	100	9
HFD31/9-L1	9	6.75	6.75	810 x (1±10%)	100	13.5
HFD31/12-L1	12	9	9	1440 x (1±10%)	100	18
HFD31/24-L1	24	18	18	3840 x (1±10%)	150	36

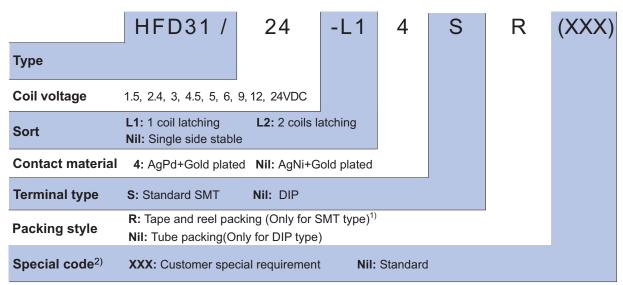
## 2 coils latching

Coil Code	Nominal Voltage VDC	Set Voltage VDC max.	Reset Voltage VDC max.	Coil Resistance Ω	Nominal Power mW approx.	Max. Voltage VDC
HFD31/1.5-L2	1.5	1.13	1.13	11.3 x (1±10%)	200	2.25
HFD31/2.4-L2	2.4	1.8	1.8	29 x (1±10%)	200	3.6
HFD31/3-L2	3	2.25	2.25	45 x (1±10%)	200	4.5
HFD31/4.5-L2	4.5	3.38	3.38	101 x (1±10%)	200	6.7
HFD31/5-L2	5	3.75	3.75	125 x (1±10%)	200	7.5
HFD31/6-L2	6	4.5	4.5	180 x (1±10%)	200	9.0
HFD31/9-L2	9	6.75	6.75	405 x (1±10%)	200	13.5
HFD31/12-L2	12	9	9	720 x (1±10%)	200	18
HFD31/24-L2	24	18	18	1920 x (1±10%)	300	36

**Notes:** 1) When user's requirements can't be found in the above table, special order allowed.

<sup>2)</sup> In case 5V of transistor drive circuit, it is recommended to use 4.5V type relay, and 3V to use 2.4V type relay.

## **ORDERING INFORMATION**

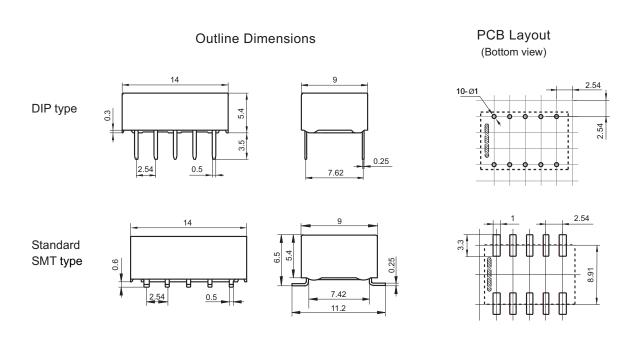


Notes: 1) R type (tape and reel) packing is moisture-proof which meets requirement of MSL-3. Please choose R type packing for SMT products. For R type, the letter "R" will only be printed on packing tag but not on relay cover. Tube packing is normally not available for SMT products unless specially requested by customer. But please note that tube packing is not moisture-proof so please bake the products before use according to description of Notice 11 herewith. In addition, tube packaging will be adopted when the ordering quantity of R type is equal to or less than 100 pieces unless otherwise specified.

Unit: mm

2) The customer special requirement express as special code after evaluating by Hongfa.

# OUTLINE DIMENSIONS, WIRING DIAGRAM AND PC BOARD LAYOUT



Remark: 1) In case of no tolerance shown in outline dimension: outline dimension  $\leq$ 1mm, tolerance should be  $\pm$ 0.2mm; outline dimension >1mm and  $\leq$ 5mm, tolerance should be  $\pm$ 0.3mm; outline dimension >5mm, tolerance should be  $\pm$ 0.4mm.

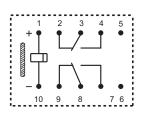
- 2) The tolerance without indicating for PCB layout is always ±0.1mm.
- 3) The width of the gridding is 2.54mm.

# **OUTLINE DIMENSIONS, WIRING DIAGRAM AND PC BOARD LAYOUT**

## Unit: mm

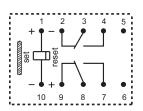
# Wiring Diagram (Bottom view)

Single side stable

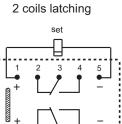


Deenergized condition

1 coil latching



Reset condition



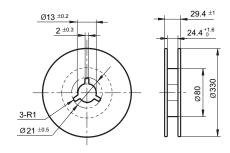
reset
Reset condition

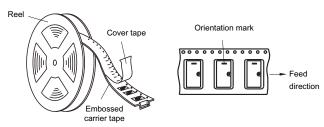
## TAPE & REEL PACKING CONSTRUCTION AND DIMENSION

Unit: mm

### **Reel Dimensions**

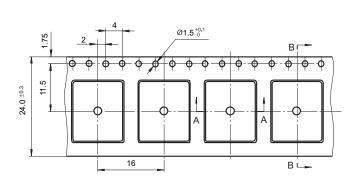
# Direction of Relay Insertion

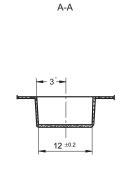


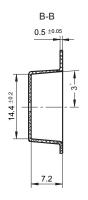


Notes: 1) Packing: 550pcs/reel, 4 reels/carton.
2) MOQ for reel packing is 550pcs.

## **Tape Dimensions**

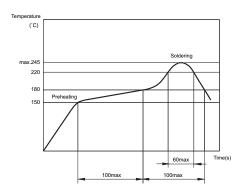






### RECOMMENDED SOLDERING CONDITIONS

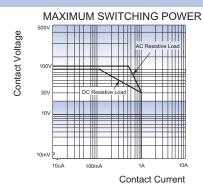
Temperature/Time profile of Reflow Soldering see below:

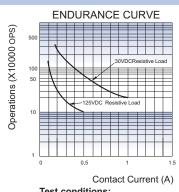


Notes: 1) Temperature profile shows Printed Circuit Board surface temperature on the relay terminal portion.

2) Please check the actual soldering condition to use other method except above mentioned temperature profiles.

### **CHARACTERISTIC CURVES**





# **Test conditions:**Resistive load, at 40°C, 1s on 9s off.

### Notice

- 1) This relay is highly sensitive polarized relay, if correct polarity is not applied to the coil terminals, the relay does not operate properly.
- 2) To avoid using relays under strong magnetic field which will change the parameters of relays such as pick-up voltage and drop-out voltage.
- 3) Relay is on the "reset" status when being released from stock, with the consideration of shock risen from transit and relay mounting, it should be changed to the "set" status when application(connecting to the power supply). Please reset the relay to "set" or "reset" status on request.
- 4) Energizing coil with rated voltage is basic for normal operation of a relay, please make sure the energized voltage to relay coil have reached the rated voltage. Regarding latching relay, in order to maintain the "set" or "reset" status, impulse width of the rated voltage applied to coil should be more than 5 times of "set" or "reset" time.
- 5) For 2 coil latching relay, do not energize voltage to "set" coil and "reset" coil simultaneously.
- 6) The relay may be damaged because of falling or when shocking conditions exceed the requirement.
- 7) For SMT products, validation with real application should be done before your series production, if the reflow-soldering temperature curve is out of our recommendation. Generally, two-time reflow-soldering is not recommended for the relay. However, if two-time reflow-soldering is required, a 60-min. interval should be guaranteed and a validation should be done before production.
- 8) Contact is recommended for suitable condition and specifications if water cleaning or surface process is involved in assembling relays on PCB.
- 9) Regarding the plastic sealed relay, we should leave it cooling naturally untill below 40°C after welding, then clean it and deal with coating, remarkably the temperature of solvents should also be controlled below 40°C.Please avoid cleaning the relay by ultrasonic, avoid using the solvents like gasoline, Freon, and so on, which would affect the configuration of relay or influence the environment.
- 10) About preferable condition of operation, storage and transportation, please refer to "Explanation to terminology and guidetines of relay".
- 11) Relays packaged in moisture barrier bags meet MSL-3 requirements. The relays should be stored at ambient conditions of ≤30 °C and ≤60% RH after they are removed from their packaging, and should be used within 168 hours. If the relays cannot be used within 168 hours, please repack them or store them in a drying oven at 25 °C ±5 °C, ≤10% RH. Otherwise, relays may be subjected to a soldering test to check their performance, or they may be used after keeping them in an oven for 72 hours at with 50 °C ±5 °C, ≤30% RH.

### Disclaimer

The specification is for reference only. See to "Terminology and Guidelines" for more information. Specifications subject to change without notice. We could not evaluate all the performance and all the parameters for every possible application. Thus the user should be in a right position to choose the suitable product for their own application. If there is any query, please contact Hongfa for the technical service. However, it is the user's responsibility to determine which product should be used only.

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